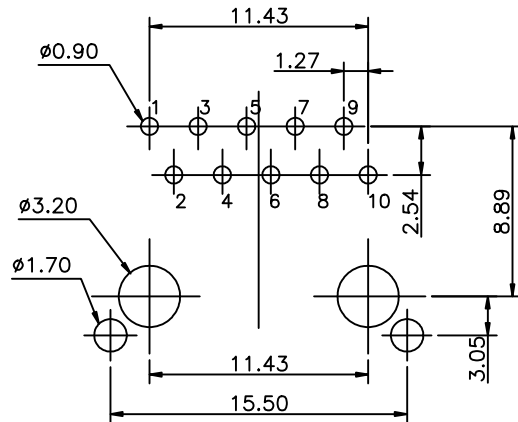


SECTION A-A



PC Board Layout Component Side Shown

NOTES:

ELECTRICAL:

- VOLTAGE RATING : 125 VAC RMS.
- CURRENT RATING : 1.5 AMP.
- CONTACT RESISTANCE : 40 MILLIOHMS MAX.
- INSULATION RESISTANCE: 1000 MEGOHMS MIN @ 500 VDC.
- DIELECTRIC STRENGTH : 1000 VAC RMS 60Hz, 1MIN.

MECHANICAL:

- HOUSING MATERIAL : GLASS FILLED POLYESTER OR HIGH TEMP UL94V-0.
- CONTACT MATERIAL : PHOSPHOR BRONZE ϕ 0.46mm.
CONTACT PLATING : GOLD PLATING OVER NICKEL.
- SHIELD MATERIAL : 0.25mm THICKNESS BRASS C2680 H. Δ
SHIELD PLATING : SELECTIVE PLATED TIN-LEAD OVER NICKEL OR PLATED NICKEL
- OPERATING LIFE : 750 CYCLES MIN.
- PCB RETENTION PRE-SOLDER : 1 LB MIN.
- PCB RETENTION POST-SOLDER : 10 LBS MIN.

ENVIRONMENTAL:

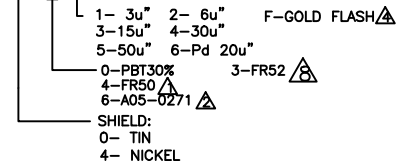
- STORAGE : -40°C TO +85°C.
- OPERATION: 0°C TO 70°C.

MATES WITH MODULAR PLUG CONFORMING TO FCC PART 68, SUBPART F.

CUL FILE NO. E163191

Δ PART NUMBER: E560X-XE0X6X

NO. OF CONTACT
8- 8 CONTACTS
1-10 CONTACTS



REVISION RECORD				
REV	ECO	DESCRIPTION	DRFT	CHKD
1		ADD PART NUMBER	LYB 9/11/02	
2		ADD PART NUMBER	LYB 10/17/02	
3		Design Modify	Syme 6/06/2003	
4		EC NOTE & NUMBER	YAN 08/14/04	
5		EC NOTE & NUMBER	SABBY 10/08/04	
6		ADD PART NUMBER	LUDJIN 02/22/05	
7		Drawing Modify	CKO 03/18/05	
8		DEL PART NUMBER	ANKLE 07/11/05	
9		Drawing Modify	YAN 09/13/05	

DETACHED LISTS	MM (INCH)		DFTO JAMIE	DATE 11/25/97
	TOLERANCES EXCEPT AS NOTED		CHKD	DATE
	MM	±	MFO	DATE
	.0 ±0.20	±	APPLV XLF	DATE 09/23/05
	.00 ±0.15	±	MATERIAL :	
.000 ±0.075	±	ANGLES ±		
THIRD ANGLE PROJECTION		QT'Y :	FINISH :	
		SCALE : 2.5:1		

FULL RISE ELECTRONIC CO., LTD

TITLE
11.5 SIDE ENTRY PCB JACK 10P

DRAWING NO. GE563004	SIZE A3	REV 9
/PART NO. SEE NOTE		
DO NOT SCALE DRAWING	SHEET X	OF Y